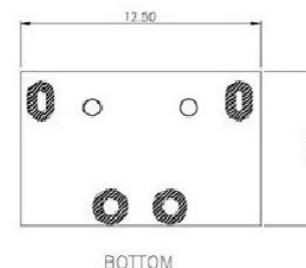
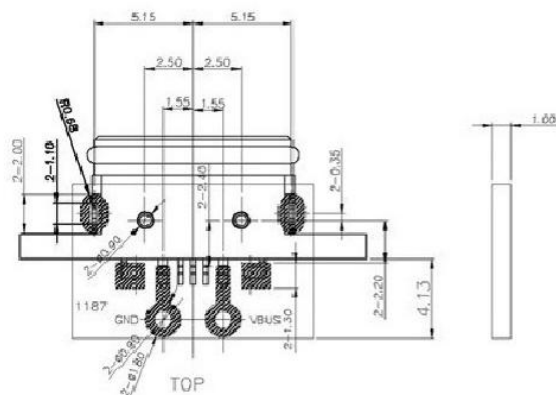


REV.	ECN. NO.	APPD.



此PCB采取OSP工艺, 且双面喷锡。

说明:

1. PCB厚度: $T=1.00 \pm 0.05\text{mm}$; 字符: 白色
2. 阴影部分为双面镀锡;
3. 图中所有孔均为镀铜通孔;

NOTES:

SPECIFICATION:

1. CURRENT RATING: 3.0A MAX
2. DIELECTRIC WITHSTAND VOLTAGE: 100VAC
3. TEMPERATURE RANGE: $-30^{\circ}\text{C} \sim 85^{\circ}\text{C}$
4. CONTACT RESISTANCE: 40 MILLIONHM MAX
5. INSULATION RESISTANCE: 100 MEGOHMS MIN.
6. INSERTION FORCE :8N~35N
7. UNMATING FORCE: 8N~35N
8. DURABILITY:1500 CYCLES

3	Shell	1	SUS 301 1/4H	
3	PLASTIC Shell	1	PA9T&LCP (G.F30%)	
2	Contact	4	BRASS C2680-EH Au/Ni Plating T=0.25mm	
1	Housing	1	PA10T (G.F30%)	
ITEM	PART NAME	Q'TY	FINISH	NOTE

X. ± 0.50	X* $\pm 2^{\circ}$	UNITS	东莞市高迪电子有限公司 DONGGUANGAODI ELECTRONICS CO., LTD.	
.X ± 0.30	.X* $\pm 1^{\circ}$	mm		
.XX ± 0.10	.XX* $\pm 0.5^{\circ}$	MAT'L	PART NO.	TITLE: IP68
.XXX ± 0.05				
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			CHKD: MARK	USB connector
			DR: JANE CHOU 2019/07/11	
				SCALE SHEET REV. 1/1 1/2 A2